



**N - CHANNEL ENHANCEMENT MODE  
POWER MOS TRANSISTORS**

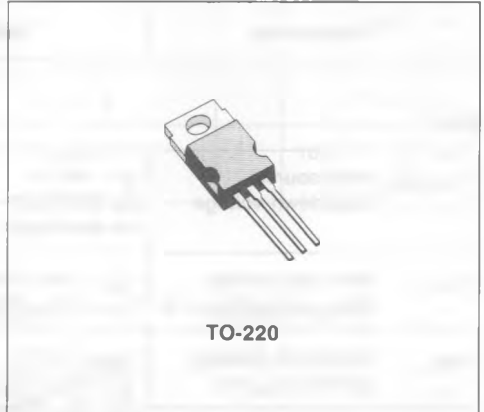
TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
SGSP321	60 V	0.13 Ω	16 A
SGSP322	50 V	0.13 Ω	16 A

- HIGH SPEED SWITCHING APPLICATIONS
- LOW VOLTAGE DC/DC CONVERTERS
- ULTRA FAST SWITCHING
- EASY DRIVE FOR REDUCED COST AND SIZE

**INDUSTRIAL APPLICATIONS:**

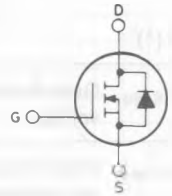
- SWITCHING POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistor. Easy drive and very fast switching times make this POWER MOS transistor ideal for high speed switching applications. Uses include motor speed control, low voltage DC/DC converters and solenoid driving.



TO-220

**INTERNAL SCHEMATIC  
DIAGRAM**



**ABSOLUTE MAXIMUM RATINGS**

	SGSP321	SGSP322	
V <sub>DS</sub>	60	50	V
V <sub>DGR</sub>	60	50	V
V <sub>GS</sub>		± 20	V
I <sub>D</sub>	16		A
I <sub>D</sub>	10		A
I <sub>DM</sub> (*)	40		A
I <sub>DLM</sub> (*)	40		A
P <sub>tot</sub>	75		W
	0.6		W/°C
T <sub>stg</sub>	- 65 to 150		°C
T <sub>j</sub>	150		°C

(\*) Pulse width limited by safe operating area

**THERMAL DATA**

$R_{thj - case}$	Thermal resistance junction-case	max	1.67	°C/W
$T_L$	Maximum lead temperature for soldering purpose		275	°C

**ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^{\circ}\text{C}$  unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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**OFF**

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}$ for <b>SGSP321</b> for <b>SGSP322</b>	$V_{GS} = 0$	60 50		V V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$	$T_c = 125^{\circ}\text{C}$		250 1000	$\mu\text{A}$ $\mu\text{A}$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA

**ON (\*)**

$V_{GS (th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu\text{A}$	2		4	V
$R_{DS (on)}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}$ $V_{GS} = 10 \text{ V}$	$I_D = 8 \text{ A}$ $I_D = 8 \text{ A}$			0.13 0.26	$\Omega$ $\Omega$

**DYNAMIC**

$g_{fs}$	Forward transconductance	$V_{DS} = 25 \text{ V}$	$I_D = 8 \text{ A}$	3			mho
$C_{iss}$	Input capacitance	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$	$f = 1 \text{ MHz}$		460	550	pF
$C_{oss}$	Output capacitance					350	pF
$C_{rss}$	Reverse transfer capacitance					180	pF

**SWITCHING**

$t_d (on)$	Turn-on time	$V_{DD} = 25 \text{ V}$	$I_D = 8 \text{ A}$		15	20	ns
$t_r$	Rise time	$V_i = 10 \text{ V}$	$R_i = 4.7 \Omega$		45	60	ns
$t_d (off)$	Turn-off delay time	(see test circuit)			40	55	ns
$t_f$	Fall time				25	35	ns

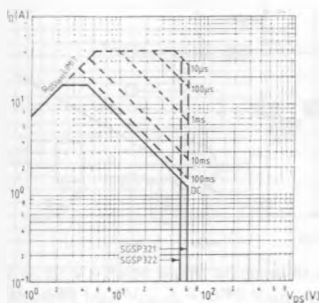
ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
$I_{SD}$ $I_{SDM}^{(*)}$	Source-drain current Source-drain current (pulsed)			16 40	A A
$V_{SD}$	Forward on voltage	$I_{SD} = 16\text{ A}$	$V_{GS} = 0$	1.4	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 16\text{ A}$ $di/dt = 25\text{ A}/\mu\text{s}$	$V_{GS} = 0$	100	ns

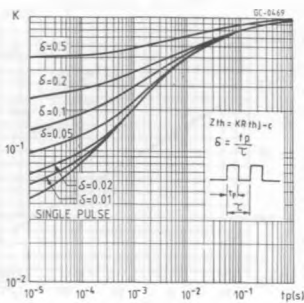
(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

(\*) Pulse width limited by safe operating area

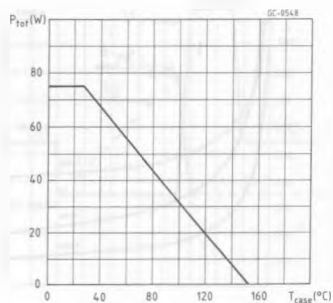
Safe operating areas



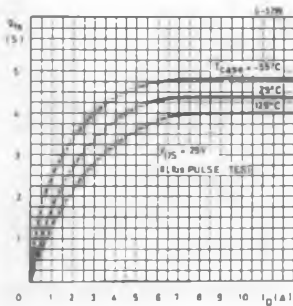
Thermal impedance



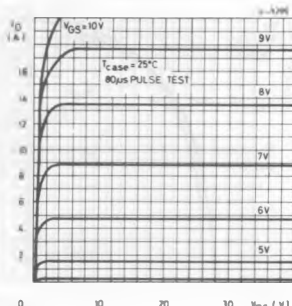
Derating curve



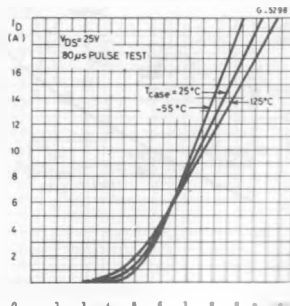
Output characteristics



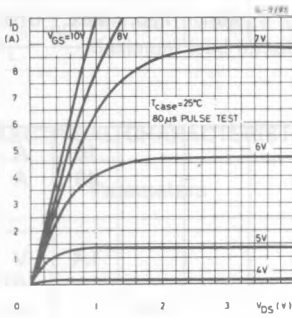
Output characteristics



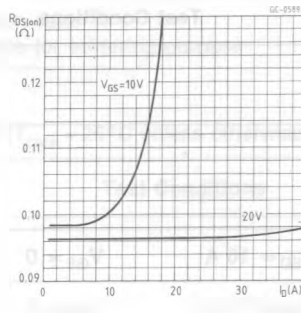
Transfer characteristics



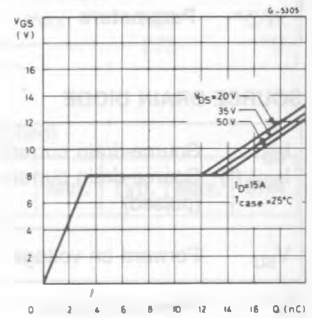
Transconductance



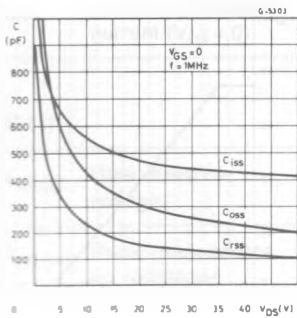
Static drain-source on resistance



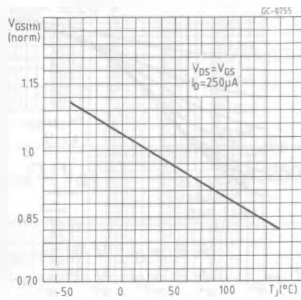
Gate charge vs gate-source voltage



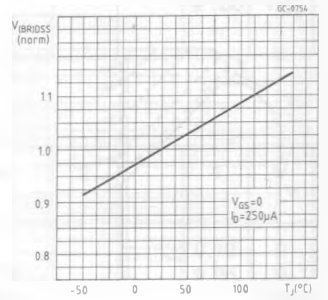
Capacitance variation



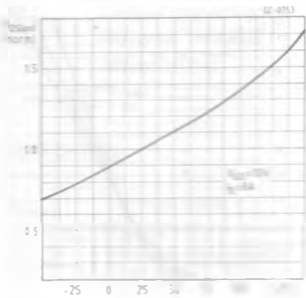
Normalized gate threshold voltage vs temperature



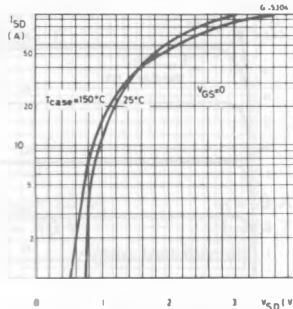
Normalized breakdown voltage vs temperature



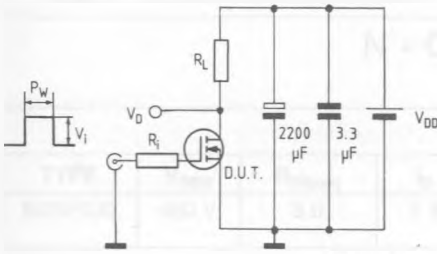
Normalized on resistance vs temperature



Source-drain diode forward characteristics



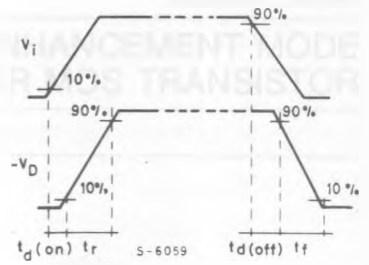
Switching times test circuit for resistive load



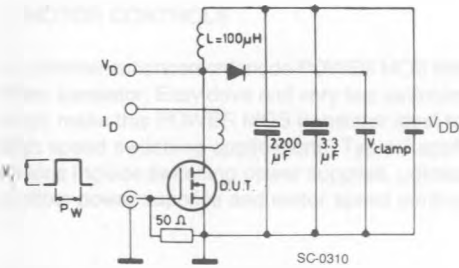
Pulse width  $\leq 100 \mu\text{s}$   
 Duty cycle  $\leq 2\%$

SC-0008/1

Switching time waveforms for resistive load



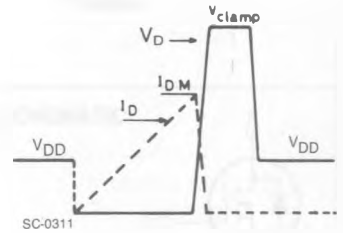
Clamped inductive load test circuit



$V_i = 12 \text{ V}$  - Pulse width: adjusted to obtain specified  $I_{DM}$ .  $V_{clamp} = 0.75 V_{(BR) DSS}$

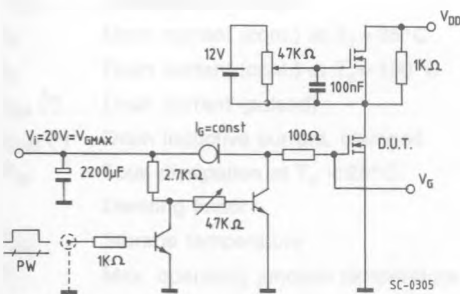
SC-0310

Clamped inductive waveforms



SC-0311

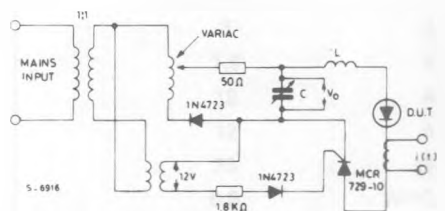
Gate charge test circuit



PW adjusted to obtain required  $V_G$

SC-0305

Body-drain diode  $t_{rr}$  measurement  
 Jedec test circuit



S-6916